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FDS6575

P-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

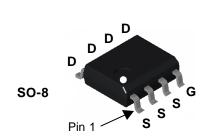
This PChannel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 8V).

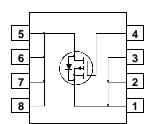
Applications

- Power management
- · Load switch
- Battery protection

Features

- -10 A, -20 V. $R_{DS(ON)}$ = 13 m Ω @ V_{GS} = -4.5 V $R_{DS(ON)}$ = 17 m Ω @ V_{GS} = -2.5 V
- Low gate charge
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High current and power handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±8	V
b	Drain Current – Continuous	(Note 1a)	-10	А
	– Pulsed		50	
PD	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.5	
		(Note 1c)	1.2	
T _J , T _{STG}	Operating and Storage Junction Temperate	ure Range	-55 to +175	°C
Therma	I Characteristics			
R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1c)	125	°C/W
R _{0JC}	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDS6575	FDS6575	13"	12mm	2500 units

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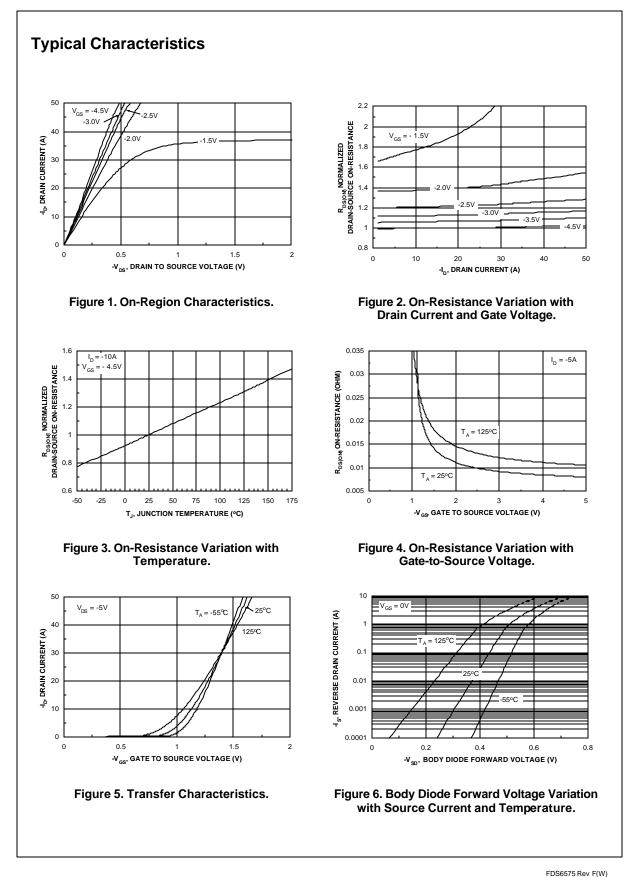
FDS6575

teristics rain–Source Breakdown Voltage reakdown Voltage Temperature pefficient ero Gate Voltage Drain Current	$V_{GS} = 0 \text{ V}, \text{ I}_D = -250 \mu\text{A}$ $\text{I}_D = -250 \mu\text{A}, \text{ Referenced to } 25^\circ\text{C}$	-20			V
rain–Source Breakdown Voltage reakdown Voltage Temperature pefficient		-20			V
pefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C			-	
ro Gate Voltage Drain Current	1		-13		mV/°C
U	$V_{DS} = -16 V$, $V_{GS} = 0 V$			-1	μA
ate–Body Leakage, Forward	$V_{GS} = 8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
ate–Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
eristics (Note 2)					
ate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.4	-0.6	-1.5	V
ate Threshold Voltage emperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		3		mV/ºC
atic Drain–Source	$V_{GS} = -4.5 \text{ V}, I_D = -10 \text{ A}$		8.5	13	mΩ
1–Resistance	66 , B				
- Ctata Drain Current		50	11	20	٨
		-50	57		A S
	V DS = -5 V, ID = -10 A		57		3
			4051		pF
					pr pF
					pr pF
•			101		P
	$V_{pp} = -10V$ $h_{p} = -1.4$		16	29	ns
,	$V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$		-	-	ns
	•		-	-	ns
urn–Off Fall Time	•			-	ns
	$V_{DS} = -10 V$. $I_D = -10 A$.		53	74	nC
0	$V_{GS} = -4.5 V$		6		nC
ate–Drain Charge			12		nC
rce Diode Characteristics	and Maximum Ratings	L	I	l	I.
				-2.1	Α
rain–Source Diode Forward Ditage	$V_{GS} = 0 \ V, \ I_S = -2.1 \ A$ (Note 2)		-0.6	-1.2	V
	ate Threshold Voltage ate Threshold Voltage emperature Coefficient atic Drain–Source n–Resistance n–State Drain Current orward Transconductance haracteristics out Capacitance utput Capacitance everse Transfer Capacitance Characteristics (Note 2) Irn–On Delay Time Irn–On Rise Time Irn–Off Delay Time Irn–Off Fall Time otal Gate Charge ate–Source Charge ate–Source Charge ate–Drain Charge Ce Diode Characteristics aximum Continuous Drain–Source ain–Source Diode Forward obtage	ate Threshold Voltage $V_{DS} = V_{GS}$, $b = -250 \ \mu A$ ate Threshold Voltage $b = -250 \ \mu A$, Referenced to 25°CImperature Coefficient $b = -250 \ \mu A$, Referenced to 25°Catic Drain–Source $V_{GS} = -4.5 \ V$, $b = -10 \ A$ $v_{GS} = -4.5 \ V$, $b = -10 \ A$ $V_{GS} = -4.5 \ V$, $b = -9 \ A$ $v_{GS} = -4.5 \ V$, $b = -10 \ A$, $T_J = 125°C$ n -Resistance $V_{GS} = -4.5 \ V$, $V_{DS} = -5 \ V$ n -State Drain Current $V_{GS} = -4.5 \ V$, $V_{DS} = -5 \ V$ $v_{GS} = -4.5 \ V$, $b = -10 \ A$ $haracteristics$ $put Capacitance$ $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$, $f = 1.0 \ MHz$ $rm-On Delay Time$ $V_{DD} = -10V$, $b = -1 \ A$, $V_{GS} = -4.5 \ V$, $R_{GEN} = 6 \ \Omega$ $rm-Off Delay Time$ $V_{DS} = -10 \ V$, $b = -10 \ A$, $V_{GS} = -4.5 \ V$ $rm-Off Fall Time$ $V_{DS} = -10 \ V$, $b = -10 \ A$, $V_{GS} = -4.5 \ V$ $rm-Off Fall Time$ $V_{DS} = -10 \ V$, $b = -10 \ A$, $V_{GS} = -4.5 \ V$ $rm-Off Fall Time$ $V_{DS} = -10 \ V$, $b = -10 \ A$, $V_{GS} = -4.5 \ V$ $rm-Off Fall Time$ $V_{DS} = -10 \ V$, $b = -10 \ A$, $V_{GS} = -4.5 \ V$ $re Diode Characteristics and Maximum Ratings$ aximum Continuous Drain–Source Diode Forward Current ain–Source Diode Forward oltage $v_{GS} = 0 \ V$, $v_S = -2.1 \ A$ (Note 2) $re purclion-to-case and case-to-ambient thermal resistance where the case thermal reference is define$	ate Threshold Voltage $V_{DS} = V_{GS}$, $b = -250 \ \mu\text{A}$ -0.4 ate Threshold Voltage $b = -250 \ \mu\text{A}$, Referenced to 25°C atte Threshold Voltage $b = -250 \ 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V_{GS} = -4.5 \ Vre-Drain ChargeV_{DS} = -10 \ V, b = -10 \ A, V_{GS} = -4.5 \ Vb = -10 \ A, V_{GS} = -4.5 \ Vre-Drain ChargeV_{DS} = -10 \ V, b = -10 \ A, V_{GS} = 0 \ V, b = -2.1 \ A (Note 2)re-Drain Continuous Drain–Source Diode Forward Currenta = 0 \ V, b$	ate Threshold Voltage ate Threshold Voltage amperature Coefficient $V_{DS} = V_{GS}, b = -250 \ \mu\text{A}$ -0.4 -0.6 ate Threshold Voltage amperature Coefficient $b = -250 \ \mu\text{A}$, Referenced to 25°C 3atic Drain–Source n–Resistance $V_{GS} = -4.5 \ V, b = -10 \ A$ 8.5n–Resistance $V_{GS} = -4.5 \ V, b = -9 \ A$ 11n–State Drain Current $V_{GS} = -4.5 \ V, b = -10 \ A$ 57haracteristics $V_{DS} = -5 \ V, b = -10 \ A$ 57but Capacitance $V_{DS} = -5 \ V, b = -10 \ A$ 57haracteristics $V_{DS} = -10 \ V, \ V_{GS} = 0 \ V, f = 1.0 \ MHz$ 884everse Transfer Capacitance $V_{DS} = -10 \ V, \ V_{GS} = 0 \ V, f = 1.0 \ MHz$ 16urn–On Delay Time $V_{DS} = -10 \ V, \ V_{GS} = -4.5 \ V, \ R_{GEN} = 6 \ \Omega$ 9urn–Off Delay Time $V_{DS} 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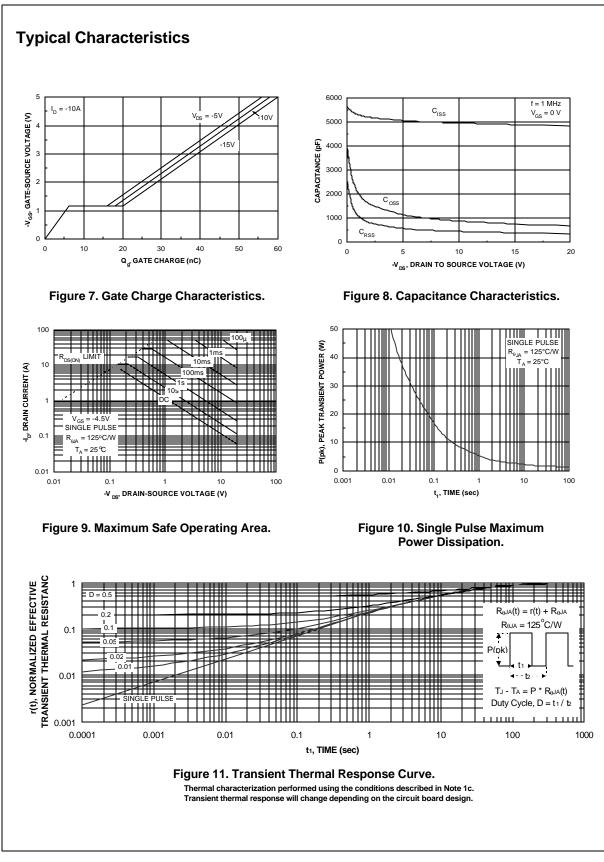
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

FDS6575 Rev F(W)



FDS6575



FDS6575 Rev F(W)

FDS6575

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